Product Preview IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on–state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications.

Features

- Extremely Efficient Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Optimized for Low Losses in IH Cooker Application
- This is a Pb–Free Device

Typical Applications

- Inductive Heating
- Consumer Appliances
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	30 15	A
Pulsed collector current, T_{pulse} limited by T_{Jmax} , 10 μ s Pulse, V_{GE} = 15 V	I _{CM}	60	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	Ι _F	30 15	A
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	60	A
Gate–emitter voltage Transient Gate–emitter voltage ($T_{pulse} = 5 \ \mu s, D < 0.10$)	V _{GE}	±20 ±25	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	278 139	W
Operating junction temperature range	Τ _J	-40 to +175	°C
Storage temperature range	T _{stg}	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

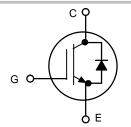
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

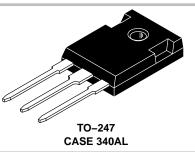


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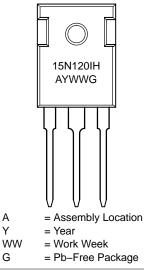
http://onsemi.com

15 A, 1200 V V_{CEsat} = 2.10 V E_{off} = 0.36 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB15N120IHWG	TO–247 (Pb–Free)	30 Units / Rail

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

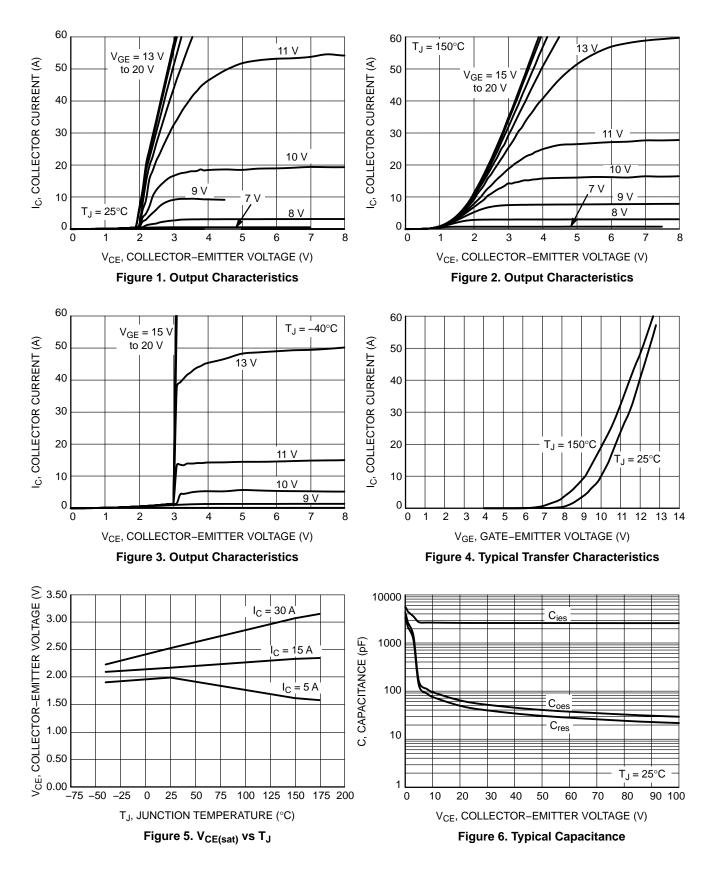
THERMAL CHARACTERISTICS

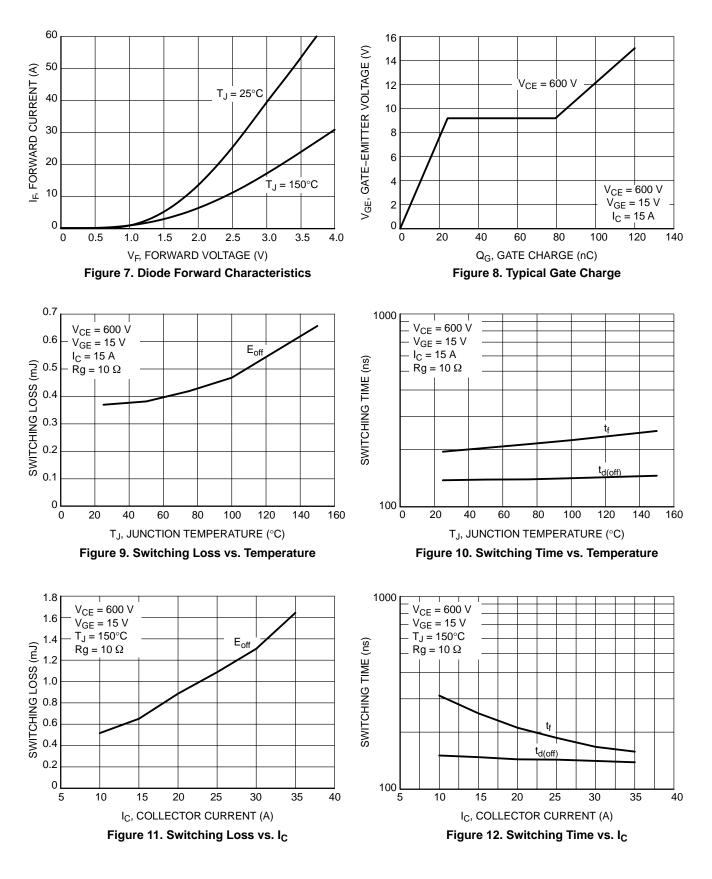
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case	$R_{ ext{ heta}JC}$	0.54	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

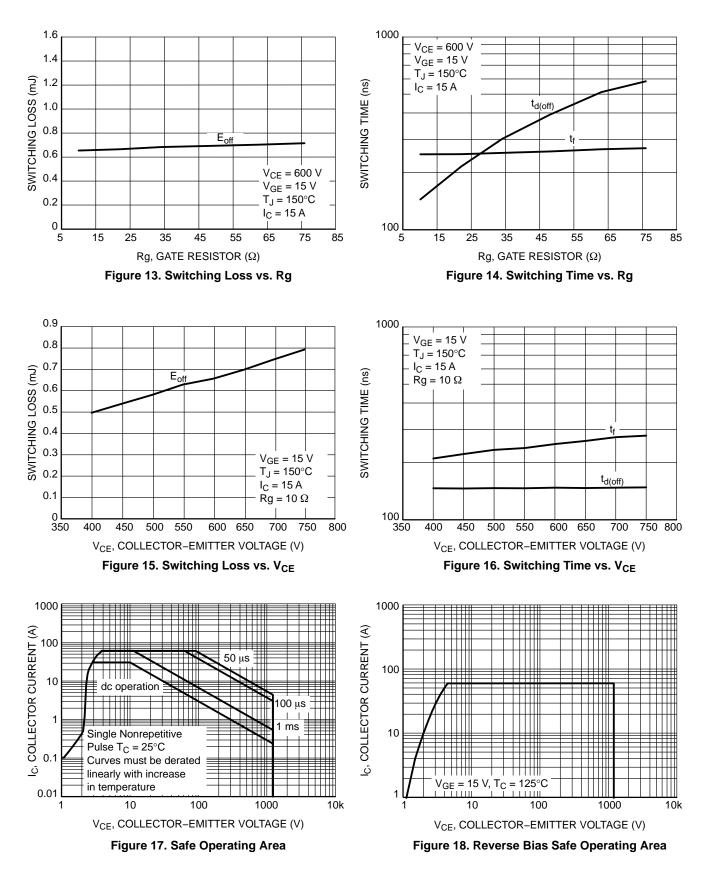
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•			•		
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	1200	_	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 15 A V _{GE} = 15 V, I _C = 15 A, T _J = 175°C	V _{CEsat}	-	2.10 2.30	2.45 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 250 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1200 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 150^{\circ}C$	I _{CES}		_ _	0.5 2.0	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	_	_	100	nA
DYNAMIC CHARACTERISTIC	•	•				
Input capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	Cies	-	2615	_	pF
Output capacitance		C _{oes}	-	65	_	
Reverse transfer capacitance		C _{res}	-	50	-	
Gate charge total		Qg	-	120	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 15 A, V _{GE} = 15 V	Q _{ge}	-	24	-	
Gate to collector charge		Q _{gc}	_	56	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-off delay time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V, }I_{C} = 15 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ }15\text{ V}$	t _{d(off)}	-	130	-	ns
Fall time		t _f	-	185	-	
Turn-off switching loss		E _{off}	-	0.36	-	mJ
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	145	-	ns
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 15 \text{ A}$ $R_g = 10 \Omega$ $V_{GE} = 0 \text{ V}/ 15 \text{ V}$	t _f	-	240	-	
Turn-off switching loss		E _{off}	-	0.65	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V _{GE} = 0 V, I _F = 15 A V _{GE} = 0 V, I _F = 20 A, T _J = 175°C	V _F	-	2.0 3.3	2.7 -	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.







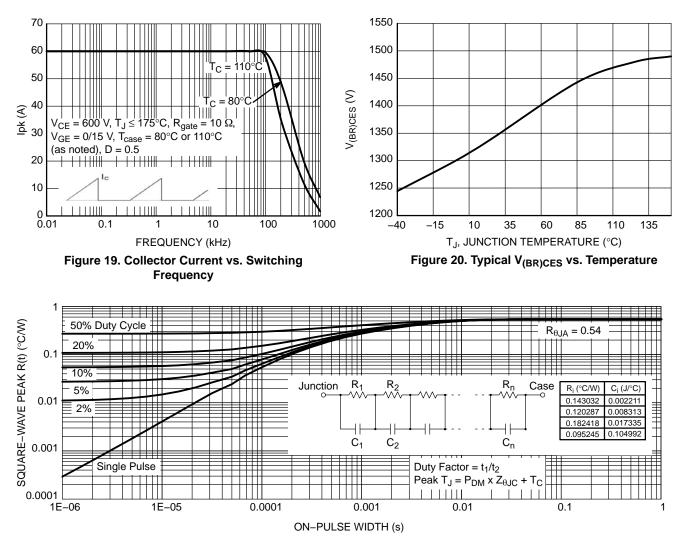


Figure 21. IGBT Transient Thermal Impedance

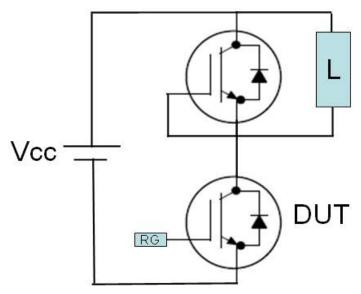


Figure 22. Test Circuit for Switching Characteristics

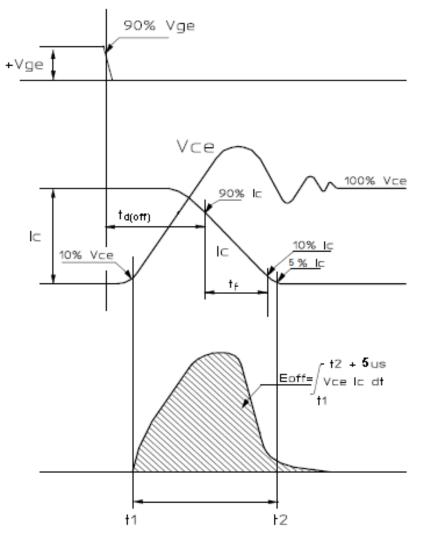
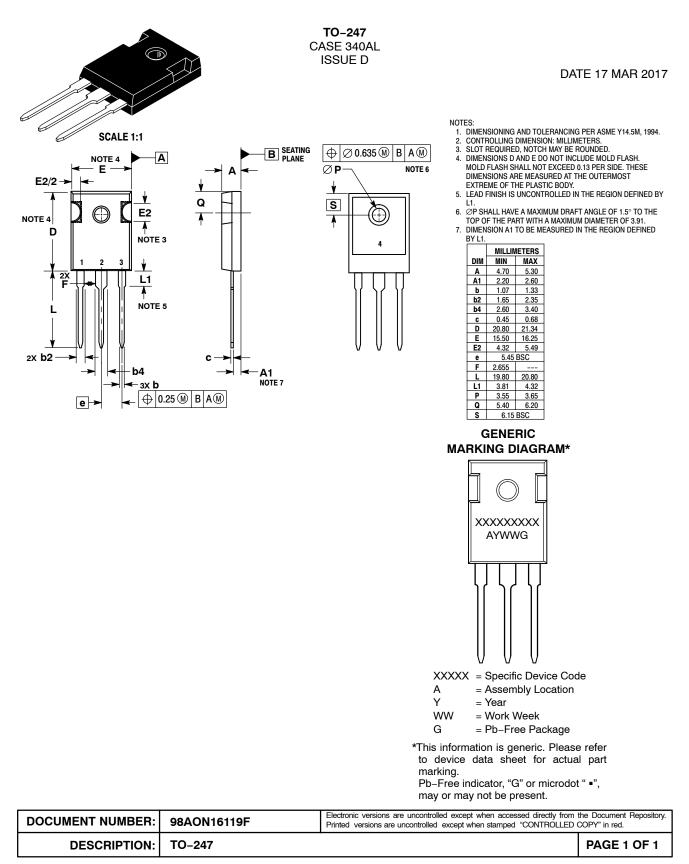


Figure 23. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





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